

# THE WORLD'S LEADING OEMS TRUST COORSTEK FOR SUPERIOR RESULTS.

## Why Choose CoorsTek?

We are the largest technical ceramics manufacturer in the world with over 40 state-of-the-art facilities on four continents. This means we have the scale, selection of materials, and capabilities to ensure on-time delivery, superior component fit and function, and optimal product life to keep our customers on the road to next-generation technology.

CoorsTek has a highly qualified staff to assist with material selection and product design. Please contact us today at +1 303 277 4701 for more information.

## Scope and Intent

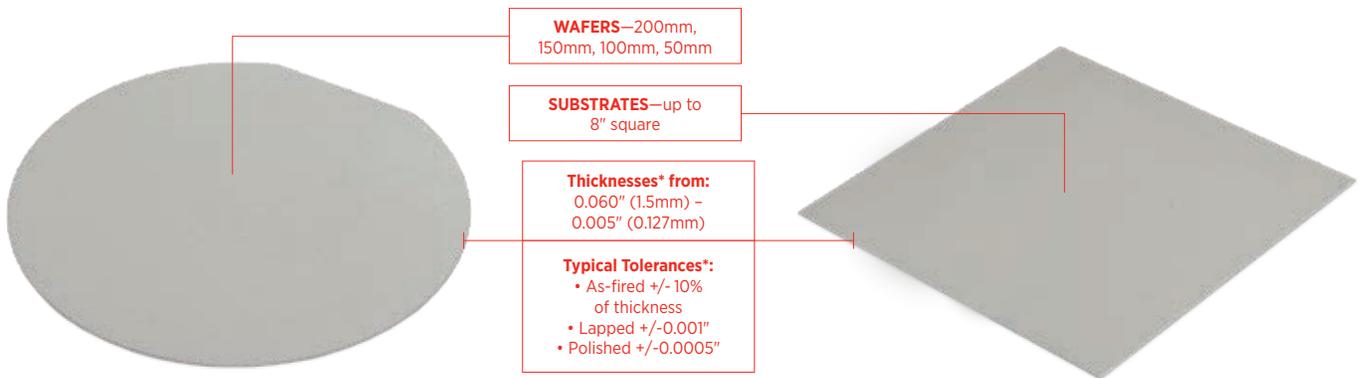
Aluminum nitride, is an ideal material for the rapidly growing LED market and other markets where high-heat dissipation is useful. CoorsTek aluminum nitride ceramic substrates feature a thermal conductivity of 170 W/m K, high dielectric strength, and a thermal expansion coefficient similar to Si, GaN, and GaAs semiconductors.

This technical specification is designed to provide a guide to common sizes, material property information, inspection methods, and quality standards for CoorsTek aluminum nitride substrates.

## Design Guidelines

### Standard Thickness and Common Sizes

CoorsTek offers a wide range of sizes and thicknesses. The table below represents our standard sizes and common thickness. Our standard length and width tolerance is ±1%, while standard as-fired thickness tolerance is ±10%. If your requirements are outside those listed below, we can customize our products to meet your needs.



\* Thickness and tolerance availability are influenced by part length and width or diameter

## Camber and Flatness

CoorsTek as-fired and lapped substrates are 100% inspected for camber using two ground, parallel plates spaced at a fixed distance by the following formula.

CoorsTek polished substrate flatness is measured in the restrained state.

$$D = T + (C \cdot L)$$

Diagram illustrating the formula  $D = T + (C \cdot L)$  with labels for each variable:

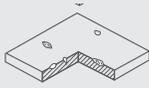
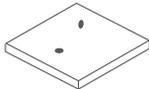
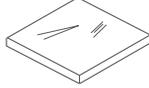
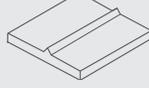
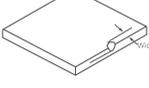
- $D$ : camber distance setting
- $T$ : substrate mode of thickness
- $C$ : camber value
- $L$ : substrate length

TABLE I — CAMBER AND FLATNESS TOLERANCES

As-Fired Camber	Lapped Camber	Polished Flatness
Standard: 0.3% (0.003"/")	0.1% (0.001"/")	0.05% (0.0005"/")
Premium: 0.2% (0.002"/")		

## Visual Criteria for Surface Imperfections

TABLE II - ALUMINA SURFACE IMPERFECTIONS

Visual Attribute		As-Fired	Lapped	Polished
<b>Burrs</b> Fragments of excess material or foreign particle adhering to the surface		None > 0.001" (0.0254 mm) high None > 0.010" (0.254 mm) diameter	None allowed	None allowed
<b>Pits, Holes, and Pocks</b> A deep depression or void		None > 0.020" (0.50 mm) diameter	None > 0.020" (0.50 mm) diameter	None allowed
<b>Stains, Spots Contamination</b>		None allowed	None allowed	None allowed
<b>Blisters</b> Bubbles or gaseous inclusion at the surface which, if broken, could form a pit, pock, or hole		None allowed	None allowed	None allowed
<b>Scratches</b> Relatively long, narrow, shallow groove or cut in the surface		None > 0.0007" (0.018 mm) deep	None > 0.0007" (0.018 mm) deep	None allowed
<b>Bumps, Fins, Ridges</b>		None allowed	None allowed	None allowed
<b>Chips</b> Open - Material broken off along an edge or corner Closed - Material has not broken off or separated		None > 0.030 (0.762 mm) substrate width X unlimited length X unlimited depth	None > 0.030 (0.762 mm) substrate width X unlimited length X unlimited depth	None > 0.030 (0.762 mm) substrate width X unlimited length X unlimited depth
<b>Cracks</b> Line of fracture without complete separation		None allowed	None allowed	None allowed

Note: The criteria in the table does not apply to substrates with surface areas greater than 20 square inches. Please specify acceptance criteria for large area substrates when requesting quotation.

TABLE III - VERIFICATION OF SURFACE IMPERFECTIONS

Surface Condition	Surface Imperfection	Verification Method
As-Fired / Lapped	Burrs, Blisters, Fins, and Ridges	0-1" (0-25.4mm) Micrometer
	Pits, Holes, Pocks, Chips, and Scratches	Low angle light, unaided eye
Polished	Burrs, Blisters, Fins, and Ridges. Pits, Holes, Pocks, Chips, and Scratches	Fluorescent lighting, unaided eye
	Stains, Spots, Contamination, Cleanliness	Polarized Microscope

### Inspection

CoorsTek uses ANSI standards for our in-process and final inspection. Tables III and IV list our standard requirements. If a customized inspection is required, please submit your requirements when requesting quotation.

# Aluminum Nitride Substrates Design Guide

## Quality Assurance

Our quality system is built around operational excellence. The CoorsTek quality system is certified to ISO 9001 which encompasses the design and manufacture of ceramic raw materials and manufacture of advanced technical ceramics.



**TABLE IV: SAMPLING PLAN: ANSI Z1.4 SINGLE SAMPLING PLAN FOR NORMAL INSPECTION**

Feature	Inspection Level	Measurement Devices
External Sizes	General Inspection Level 1 AQL 1.0	Calipers, Micrometers
Internal Feature Location and Size	Special Inspection Level S-2 AQL 1.5	Optical Measurement
Dye Check	Special Inspection Level S-2 AQL 1.5	Dye Penetrant
Surface Finish	3 parts per lot	Profilometer
Camber (As-Fired/Lapped), Final Inspection	General Inspection Level 1 AQL 0.65	Camber Bar
Camber (As-Fired/Lapped), In-Process	100%	
Flatness (Polished), Final inspection	General Inspection Level 1 AQL 0.65	Dial Indicator
Flatness (Polished), In-Process	100%	
Visual, Final Inspection	General Inspection Level 1 AQL 1.5	See Table IV
Visual, In-Process	100%	
Density	3 parts per lot	ASTM-C373

## MATERIAL PROPERTIES

PROPERTY	UNITS	TEST METHODS	ALN-170
Thermal Conductivity 25° C	W/(m K)	ASTM E1461	≥ 170
Nominal Density	g/cm <sup>3</sup>	ASTM C373	3.31
Surface Finish		Profilometer	
As-Fired (Ra)	μinch (micron)	5.08 μm Radius Stylus	≤ 25 (≤ 0.6)
Lapped		2,540 μm Cutoff	≤ 25 (≤ 0.6)
Polished		ANSI/ASME B46.1	≤ 2 (≤ 0.05)
Flexural Strength	MPa	ASTM-F394 (Bi-Axial Method)	> 350
CTE - 25° - 400° C	10 <sup>-6</sup> /°C	ASTM C372	4.4
Dielectric Strength (60 cycles AC avg. RMS), 0.635mm thick	Kv/mm (room temp)	ASTM-D149	≥ 15
Dielectric Constant (Relative Permittivity), 1 MHz	@ 25° C	ASTM D150	9
Dissipation Factor (Loss Tangent) 1MHz	@ 25° C	ASTM D150	0.002
Loss Index (Loss Factor) 1MHz	@ 25°C	ASTM D150	0.0016
Volume Resistivity, 25° C	ohm-cm	ASTM D257	> 10 <sup>14</sup>

Charts intended to illustrate typical properties. Property values vary with method of manufacture, size, and shape of part. Data contained herein is not to be construed as absolute and does not constitute a representation or warranty for which CoorsTek assumes legal responsibility. CoorsTek Aluminum Nitride substrates meet the requirements of the European Union (EU) Directive on Restriction of Hazardous Substances (RoHS). The EU Directive on RoHS specifies that an electronic product or component may not contain a listed substance except as specifically provided in the directive. CoorsTek is a registered trademark of CoorsTek, Inc.



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